Moderní experimentální metody Elektronová spektroskopie a mikroskopie IV

Elektronová mikroskopie

- Transmisní
- Rastrovací
- Běžné přidružené analytické metody
 - EDS, WDS
 - EELS
- Elektronová difrakce
 - EBSD
 - LEED
 - RHEED

History of electron microscopy

- First transmission electron microscopy Ernst Ruska 1931
- First Czechoslovak electron miscoscope – Armin Delong late 1940's
- Scanning electron microscopy – Zvorykin 1942
- Aberation corrected electron microscopy
 - atomic resolution
 - Ondrej Krivanek 1970's





Basic Microscope Classifications



Charged particle microscope



Comparing Microscopes

	LIGHT MICROSCOPE	ELECTRON MICROSCOPE
The source of illumination	The ambient light source is light for the microscope	Electrons are used to "see" – light is replaced by an electron gun built into the column
The lens type 🕨 🕨	Glass lenses	Electromagnetic lenses
Magnification method	Magnification is changed by moving the lens	Focal length is charged by changing the current through the lens coil
Viewing the sample	Eyepiece (ocular)	Fluorescent screen or digital camera
Use of vacuum 🕨	No vacuum	Entire electron path from gun to camera must be under vacuum

CORE TECHNOLOGY: The Electron Gun

- Three main sources of electrons:
 - Tungsten
 - LaB6 (lanthanum hexaboride)
 - Field Emission Gun (FEG)
- Different costs and benefits of each
- Each selected primarily for their brightness



Electron guns

- With field emission guns we get a smaller spot and higher current densities compared to thermionic guns
- Vacuum requirements are tougher for a field emission guns



CORE TECHNOLOGY: Electromagnetic Lenses



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What is a Transmission Electron Microscope?







Fig. 2.31. Schematic diagram of the interactions between high-energy electrons and matter in TEM.



Fig. 2.32. Atomistic view of interaction processes between incident high-energy electrons and electrons of an individual atom.



JKU Linz, Graz 10% Mn Bi₂Te₃

HAADF STEM





TEM Aberration Correction



- Chromatic aberration is distortion that occurs when there is a failure of a lens to focus all colors (wavelengths) to the same convergence point.
 - Correcting the aberration is necessary, otherwise the resulting image would be blurry and delocalized, a form of aberration where periodic structures appear to extend beyond their physical boundaries.
 - Recent improvements in aberration correction have resulted in significantly-improved image quality and sample information.
- Spherical aberration occurs when parallel light rays that pass through the central region of the lens focus farther away than the light rays that pass through the edges of the lens.
 - Result is multiple focal points and a blurred image.

What is Scanning Transmission Electron Microscopy?



STEM image of a 32nm semiconductor device

EDX map of semiconductor device

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What is a Scanning Electron Microscope?



Comparing SEM and TEM

		TEM	SEM
Electron Beam		Broad, static beams	Beam focused to fine point; sample is scanned line by line
Voltages Needed		TEM voltage ranges from 60-300,000 volts	Accelerating voltage much lower; not necessary to penetrate the specimen
Interaction of the beam electrons		Specimen must be very thin	Wide range of specimens allowed; simplifies sample preparation
Imaging		Electrons must pass through and be transmitted by the specimen	Information needed is collected near the surface of the specimen
Image Rendering	•	Transmitted electrons are collectively focused by the objective lens and magnified to create a real image	Beam is scanned along the surface of the sample to build up the image







MENA3100



Sekundární elektrony – topografický kontrast

Zpětně odražené – chElectron microscopyický kontrast





SEM combined with Energy dispersive spectrometer (EDS) and Wavelength Dispersive Spectrometer (WDS).

WDS spectrometers







What is a Focused Ion Beam? (FIB)



Physical Failure Analysis



Fig. 1.9 Energy-loss spectrum of a 25-nm germanium film showing phonon and vibrational modes, as well as intraband electronic transitions (Schröder, 1972)



Fig. 2.35. Typical EEL spectrum and corresponding energy-level scheme.









Fig. 2.32 Components of the Zeiss SESAM instrument: (a) electrostatic omega filter (dispersion $\approx 12 \ \mu$ m/eV at the midplane slit) and (b) MANDOLINE filter, whose dispersion at the energy-selecting plane exceeds 6 μ m/eV





electron beam within a thin specimen. X-rays are emitted from the dotted region, whereas the energy-loss spectrum is recorded from the hatched region, the spectrometer entrance aperture having a collimating effect. Auger electrons are emitted within a small depth



Fig. 1.14 (a) HAADF-STEM image of a [100]-projected GaAs specimen, showing bright Ga and As atomic columns. (b) EELS image showing the Ga-L₂₃ intensity in *green* and As-L₂₃ intensity in *red*. (c) EDX spectroscopy image with Ga-K α intensity in *green* and As-K α intensity in *red*. Courtesy of M. Watanabe

Fig. 3.7 Angular dependence of the differential cross sections for elastic and inelastic scattering of 100-keV electrons from a carbon atom, calculated using the Lenz model (Eqs. (3.50, (3.7), and (3.15)). Shown along the horizontal axis are (from left to right) the characteristic, median, mean, root-mean-square and effective cutoff angles for total inelastic scattering, evaluated using Eqs. (3.53), (3.54), (3.55), and (3.56)





Fig. 3.26 (a) Schematic and contour plot (*gray background*) showing the calculated energy loss and angular dependence of intensity for a 50-nm Si specimen and 300-keV incident electrons. (b) Energy-loss spectra calculated from Eq. (3.84) for 2.1-mrad collection semi-angle, 300-keV incident electrons, and various thicknesses of silicon, assuming no surface-oxide later. The intensities are normalized and the spectra displaced vertically for clarity. Reproduced from Erni and Browning (2008), copyright Elsevier. A computer program for evaluating Eq. (3.84) is described in Appendix B9



Α

K M' K'

Γ"



Figure 1. (A) Principle of the experimental set-up. About 6-nm wide incoming electron beam is scattered by a thin sample and a line in the resultant diffraction pattern is selected by a slot aperture. The selected beams pass through the spectrometer, which disperses them in the energy direction, and a momentum-energy $(q-\omega)$ pattern that analyzes a line section through one or more Brillouin zones is projected onto the detector. (B-D) STEM-EELS-derived Phonon dispersions derived from STEM/EELS energy loss (upper halves) and energy gain (lower halves) at 300 K (**B**), 800 K (**C**), and 1300 K (**D**) along the high-symmetry momentumtransfer path connecting the first and third BZs, from Γ to Γ'' , shown in the diagram in (**E**). (**F**) Calculated phonon dispersion for each temperature along the same path. (F) Zoom-in of the energy axis in (G) to better illustrate the optical-mode shifts.

High-temperature phonons in h-BN: momentum-resolved vibrational spectroscopy and theory

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Arxiv:2310.13813

EBSD



EBSD



The EBSP contains the angular relationship between the planes, the symmetry of the crystal and orientation information

Bright 'Kikuchi' bands correspond to planes in the crystal lattice

Width of bands is dependent upon electron wavelength and lattice plane spacing

Relationship is given by the Bragg equation $\lambda = 2d \times \sin\theta$



FIGURE 2.8. Electron interaction with crystalline material. (Adapted from [13].)
EBSD



FIGURE 2.6. Venables' early EBSP indexed by modern software. The cross shows the computed location of the pattern center. Graphic inset shows approximate orientation of the crystal with respect to the sample surface.

EBSD

Titanium Grain Structure



Once the grain shape is known, the orientation of the major axis can also be examined to understand growth mechanisms.





Electron diffraction Schéma LEED



LEED

- Typické energie 20 eV až 200 eV, ve směru normály povrchu
- Kvalitativně:
 - Z pozice spotů lze zjistit také velikost, symetrii, atd. absorbátů na povrchu, lze samozřejmě analyzovat i jen samotný substrát
- Kvantitativně:
 - Přesné pozice atomů lze zjistit z měření intenzit, závislosti I-V, porovnáním s teorií a modely
 - Profil intenzit jednotlivých spotů

Co se stane pokud zvýšíme energii elektronů

- Nízká
 - Zde jen n = 1 pro úhly θ , viz podmínka pro vznik maxim.





Diffraction Pattern



Real Space - fcc(110) surface

- Vyšší
 - (dvojnásobná)





Si 7x7





	information extracted from LEED spots						
	spot shape	spot profile	surface structure				
a	•	A		ideal surface			
b	••	<u> </u>		regular steps			
C	•	FWHM		random steps			
d	O	Ŵ		regular size or islands regular distance			
e	*	FWHM		random size and distance islands			

Gronwald and Henzler M. Surf. Sci. 117 (1982)



Gronwald and Henzler M. Surf. Sci. 117 (1982)

Simultaneous Inspection of Several Diffraction Spots

Mg/Ag(100)



K. Tegenkamp, M. Michailov, H. Pfnuer: Appl. Surf. Sci., 151, 40 (1999) NATO – ASI series, vol. 360, (1997)

RHEED

- Typické energie 5 keV až 100 keV,
- Charakteristiky
 - Dopředný rozptyl
 - Úhel rozptylu





Figure 2. (a) Direct space and reciprocal space of RHEED. (b) RHEED pattern taken from a Si(1 1 1)–(7 × 7) reconstructed surface. The electron beam was 15 keV in energy with [112] incidence in azimuth direction and about 3° in glancing angle θ_g to attain a surface-wave resonance condition.



Figure 3. Schematics of various kinds of realistic surfaces, in real-space morphology, in reciprocal space, and their RHEED patterns (courtesy by Yoshimi Horio).



Figure 4. RHEED patterns observed during Ag deposition onto Si(1 1 1) –(7 \times 7) reconstructed surface (**a**) at room temperature (**b**)(**c**) and at 440°C (**d**) (**e**). The amount of Ag deposited is (b) 1.5 ML, (c) 3.0 ML, (d) 0.5 ML, and (e) 1.0 ML. ML (monolayer) means a single-atomic layer. Reprinted from (Hasegawa et al., 1987), Copyright 1987, with permission from Elsevier.



Figure 10. RHEED intensity oscillation and crystal growth monitor. (a) and (b) Specular beam from a flat surface and a stepped surface, respectively. (c) Illustrations showing a 2D-island growth style and (d) the intensity change of specular spot during the growth, reprinted from (Joyce et al., 1986), Copyright 1986, with permission from Elsevier. (e) Experimental data of RHEED intensity oscillations during Ge homoepitaxy on Ge(111) surface (Fukutani et al., 1992).

Incident beam	Detected signal	Examples	Resolution (nm)
Electron	Electron	Electron microscopy (TEM, STEM)	0.1
		Electron diffraction (SAED, CBED)	10-1000
		Electron energy-loss spectroscopy (EELS)	<1
		Auger electron spectroscopy (AES)	~ 2
	Photon	X-ray emission spectroscopy (XES)	2-10
		Cathodoluminescence (CL)	
Ion	Ion	Rutherford backscattering spectroscopy (RBS)	1000
		Secondary ion mass spectrometry (SIMS)	50
		Local electrode atom probe (LEAP)	0.1
	Photon	Proton-induced x-ray emission (PIXE)	500
Photon	Photon	X-ray diffraction (XRD)	30
		X-ray absorption spectroscopy (XAS)	20
		X-ray fluorescence spectroscopy (XRF)	
	Electron	X-ray photoelectron spectroscopy (XPS)	5-10
		Ultraviolet photoelectron spectroscopy (UPS)	1000
		Photoelectron microscopy (PEM or PEEM)	0.5
	Ion	Laser microprobe mass analysis (LAMMA)	1000
	Ion	Laser microprobe mass analysis (LAMMA)	1000

Table 1.1 Imaging and analysis techniques employing electron, ion, and photon beams, with estimates of the achievable spatial resolution